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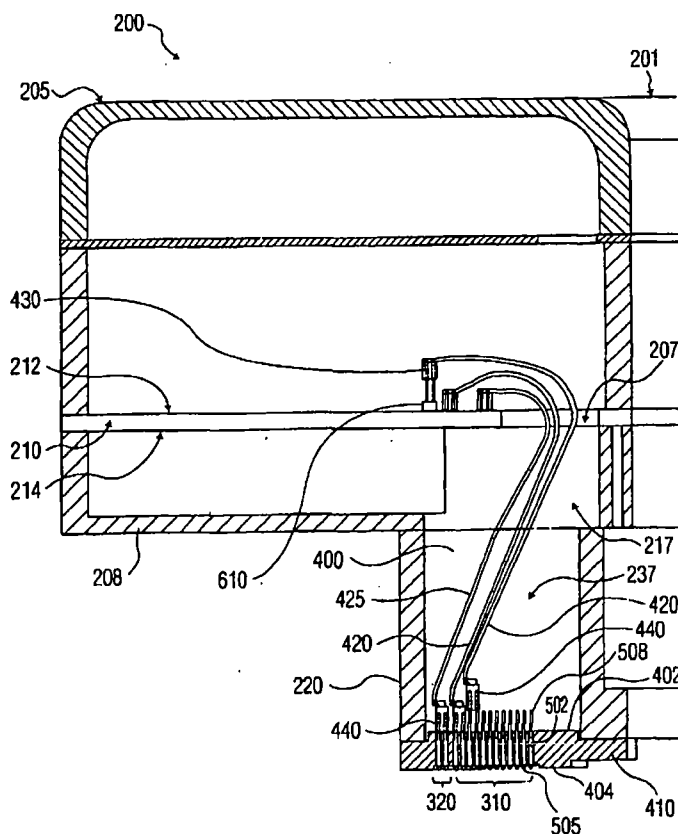
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(54) Title: FLEXIBLE INTERFACE FOR A TEST HEAD



(57) Abstract: A connection module for use with a test head system is provided, the test head system including a test head for testing devices. The connection module includes a plurality of flexible circuits for transmitting and receiving signals between electronics in the test head and a device to be tested. The connection module also includes connection points on a first end of each of the flexible circuits for connecting the flexible circuits to the electronics in the test head.



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